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<b>(21) International Application Number:</b> PCT/KR98/00461 <b>(22) International Filing Date:</b> 24 December 1998 (24.12.98)  <b>(30) Priority Data:</b> 1997/73505 24 December 1997 (24.12.97) KR  <b>(71) Applicant (for all designated States except US):</b> KOREA RE- SEARCH INSTITUTE OF CHEMICAL TECHNOLOGY [KR/KR]; 100, Jang-dong, Yusung-ku, Daejeon 305-343 (KR).  <b>(72) Inventors; and</b> <b>(75) Inventors/Applicants (for US only):</b> LEE, Kew, Ho [KR/KR]; 133-205, Hanbit Apt., 99, Uheun-dong, Yusung-ku, Dae- jeon 305-333 (KR). NAM, Seung, Eun [KR/KR]; 106-506, Sejong Apt., Junmin-dong, Yusung-ku, Daejeon 305-390 (KR). LEE, Sang, Hak [KR/KR]; 376-8, Daeheung-3 dong, Joong-ku, Daejeon 301-013 (KR). RYU, Jeong, Yong [KR/KR]; 111-202, Hanwool Apt., Shinsung-dong, Yusung-ku, Daejeon 305-345 (KR).  <b>(74) Agent:</b> HUH, Sang, Hoon; Hyecheon Building, 13th floor, 831, Yeoksam-dong, Kangnam-ku, Seoul 135-792 (KR).		<b>(81) Designated States:</b> CA, JP, US, European patent (AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE).  <b>Published</b> <i>With international search report.</i>
<b>(54) Title:</b> METHOD FOR PREPARING COMPOSITE MEMBRANE FOR SEPARATION OF HYDROGEN GAS  <b>(57) Abstract</b>  The present invention relates to a method for preparing a composite membrane for separation of hydrogen gas and more particularly, to a method for preparing the composite membrane with better permeation and separation coefficient on hydrogen gas, prepared in such a manner that an alloy consisting of a palladium complex compound and transition metal is electroplated on a modified porous supporting membrane under vacuum, thereby forming the thin plated-layer without pin-hole.		

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## METHOD FOR PREPARING COMPOSITE MEMBRANE FOR SEPARATION OF HYDROGEN GAS

### BACKGROUND OF THE INVENTION

#### 5 Field of the Invention

The present invention relates to a method for preparing a composite membrane for separation of hydrogen gas and more particularly, to a method for preparing the composite membrane with better permeation and separation coefficient on hydrogen gas, prepared in such a manner that an alloy consisting  
10 of a palladium complex compound and transition metal is electroplated on a modified porous support under vacuum, thereby forming the thin plated-layer without pin-hole.

#### Description of the Related Art

15 Generally, it is advantageous to use a material with larger permeation and separation coefficients as a membrane for separation of a hydrogen gas. When the hydrogen gas is separated by a membrane derived from an organic polymer, the membrane manifests some poor physical properties such as its thermal stability, chemical resistance and durability. In particular, the  
20 selectivity of membrane to a certain gas tends to be lowered as its gas permeability becomes larger, and thus a highly purified hydrogen cannot be obtained.

Meanwhile, a palladium-based separation membrane has a higher solubility and diffusion property to the hydrogen gas so that the selective  
25 separation of hydrogen gas may be available through its dense surface. In this context, some metals such as palladium has been mainly used so as to obtain a highly purified hydrogen from a mixing gas containing hydrogen.

However, the use of pure palladium membrane for the hydrogen

separation is restricted, as hydrogen embrittlement caused by the transition between the  $\alpha$ - and  $\beta$ -phase occurs in membranes in contact with hydrogen at temperature below 300°C and pressure below 2 MPa. Since the lattice constant of the  $\beta$ -phase is at least 3% larger than that of the  $\alpha$ -phase, the nucleation and growth of the  $\beta$ -phase cause strains in the metal and thereby the embrittlement of the material.

To comply with this matter, a method of using an alloy containing palladium and other metals has been suggested instead of use of pure palladium; With its proper prevention of any hydrogen saturation and interaction between a metal plated in the form of substitution and hydrogen atom, a palladium-alloy membrane may serve to prevent the regular arrangement of hydrogen atom within the lattice and thus, any formation of a beta phase does not occur. The palladium-alloy membrane may further enhance the selectivity to hydrogen gas and durability, compared with a separation membrane derived from pure palladium. In particular, in order to improve the performance of membrane, a method of coating palladium thinly on a porous support has been under consideration and some studies on such composite-type separation membrane has been mainly conducted.

As disclosed in US Patent No. 2,773,561, the use of pure palladium or palladium-based alloy membrane with some metal in the absence of the composite-type separation membrane has some disadvantages in that a) this method is uneconomical due to an excess use of palladium in a membrane, and b) since the thickness of membrane should be in the range of 25-150  $\mu\text{m}$  to endure the temperature and pressure, its larger thickness may lower the permeation rate.

In this respect, it is recommended that a palladium composite membrane containing a thin palladium or palladium alloy membrane on its support, be employed as a separation membrane for hydrogen gas instead of

palladium metal membrane or thin palladium alloy membrane.

Examples of the existing materials used for a support of a palladium composite membrane includes glass [Chem. Lett., 10, 1687(1988)], inorganic materials such as porous ceramics [Ind. Eng. Chem. Res., 33, 616(1994)]; J. Memb. Sci., 56, 315(1991)) and stainless steel [J. Memb. Sci., 181(1993)]. Whereas the weak strength of the glass and porous ceramics are susceptible to easy destruction and the sealing between a separation membrane and permeation cell may not be made available, a porous support derived from a stainless steel has several advantages such as a) lower material cost, b) little occurrence of corrosion and crack, c) easier processing, and d) higher mechanical strength for modulation.

In addition, examples of the plating methods designed to prepare a palladium composite membrane by means of coating palladium metal membrane and palladium alloy membrane on porous support includes a) electroless plating (J. Memb. Sci., 77, 181(1993); Ind. Eng. Chem. Res., 32, 3006(1993)), b) chemical vapor deposition (Ind. Eng. Chem. Res., 33, 616(1994); J. Memb. Sci., 120, 261(1996)) and c) sputtering (J. Memb. Sci., 94, 299(1994); J. Memb. Sci., 104, 251(1995)).

The electroless plating method comprising a variety of multi-pretreatment steps and several repeated activation steps at the surface of support has several disadvantages in that a) more prolonged treatment time is required, b) the thickness of film may be controllable due to continuous plate growth, and c) the excellent capacity of membrane may be hardly expected, since a membrane with a thickness of 10-20  $\mu\text{m}$  should be prepared to form a pinhole-free layer.

The chemical deposition (CVD) method has also been used to coat thin films of thickness below 5  $\mu\text{m}$ . Although the CVD method could prepare highly selective films, it required too high purity of constituents and strict conditions

in view of an economical aspect. Also, since the CVD method cannot form ally, the method forms  $\beta$ -phase which induces hydrogen embrittlement.

The sputtering method has little separation effect of hydrogen gas via a palladium layer due to difficulty in forming defect-free film.

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## SUMMARY OF THE INVENTION

Therefore, an object of this invention is to provide a method for preparing a composite membrane for separation of hydrogen gas with improved permeability and separation capability to hydrogen gas, wherein an  
10 palladium alloy compound is electroplated on a porous support; instead of using palladium, a palladium complex compound is applied so as to lessen the difference of standard electropotential between palladium and transition metal used as alloy metal; the surface of porous support is modified to form a homogeneous, thin and pinhole-free layer; in particular, during  
15 electrodeposition, the thickness of an electrodeposited layer, so formed in the presence of vacuum, is thinly adjusted to further enhance the permeation and selectivity to hydrogen gas from a mixing gas containing hydrogen.

## Detailed Description of the Invention

20 This invention is characterized by a method for preparing composite membrane for separation of hydrogen gas using palladium, wherein an alloy containing palladium and transition metal is electroplated on a porous support.

This invention is explained in more detail as set forth hereunder:

This invention relates to a method for preparing a composite membrane  
25 where a palladium alloy complex in the form of homogenous and thin membrane is located, without any pin-hole formation, at one surface of porous support having possibly homogeneous micropores, to the extent that the diffusion of gas may not be affected. To this end, some major characteristics of

this invention are that;

- a palladium complex compound is used;
- the surface of support is modified to thinly adjust an alloy layer without any pin-hole formation;
- 5       - an electroplating method under vacuum state is applied.

According to this invention, an electroplating method is applied so as to form a palladium alloy membrane on the porous support. Under the conventional method, this method is not only simple and easy to adjust a thickness of the composite membrane, but also economical in that less time is  
10       required than the electroless plating and chemical vapor deposition.

In case of applying a general electroplating method designed to form a palladium alloy membrane, the amount of palladium from the composition of alloy is not easily adjusted due to big difference of standard electropotential between palladium and transition metal. For example, the standard  
15       electropotential of palladium and nickel used as a transition metal is 0.987V and -0.250V, respectively, and a difference of standard electropotential between both is 1.237V. In this regard, when a direct current is given, the plating amount of palladium is larger than a transition metal due to more rapid plating rate of the former and thus, an alloy with a desired chemical composition cannot be  
20       prepared.

To overcome such shortcomings associated with the application of electroplating method, this invention has introduced a method of electroplating an alloy derived from a palladium complex compound and transition metal on a porous support; more specifically, the whole molecules present in the support  
25       is electrically neutralized to lower a difference of standard electropotential, thus being easy to adjust a composition of alloy, using the palladium complex compound.

According to this invention, the method for preparing a composite

membrane for separation of hydrogen gas is explained in more detail as follows:

The first step is to prepare a palladium complex compound. In case of the complex compound using palladium and ligand, it is preferred to select the ligand which has a strongly coordinate with palladium in aqueous solution and which does not form any other complex compound. The typical examples of ligand include ethylene diamine, diethylene diamine, tetraammonia and diammonia; among them, it is more preferred to select ethylene diamine. The manufacturing process of the palladium complex compound is based on the existing method[Hydmen Gijutsu, M. Matsunaga, M. Hara, A. Ablimit, Y. Tsuru and K. Hosokawa, 43(10), 987(1992)].

The second step is to prepare an alloy using the palladium complex compound, so formed above and transition metals.

The examples of the transition metal includes VIII group elements such as Pt, Rh, Ir, Fe, Co and Ni; IB group elements such as Cu, Ag and Au; VIA group elements such as Cr, Mo and W; IVA group elements such as Ti and Zr; and VA group element such as Ta, Nb and V; It is preferred to select VIII group elements, more preferably Ni.

Also, it is preferred that to rapidly facilitate the alloy between the palladium complex compound and transition metal, the transition metal is for the form of ion compound.

Further, it is preferred that the amount of palladium is in the ratio of more than 50% by weight to the total weight of the alloy and more preferably, the ratio of the palladium to the transition metal is in the range of 50:50-90:10 wt%.

The process for manufacturing the composite membrane designed to electroplate palladium alloy on a porous support is as follows:

In order to manufacture a homogeneous membrane without pin-hole

based on the conventionally available electroplating method, the thickness of an electroplated layer should be more than 5  $\mu\text{m}$  but such range of thickness may induce a poor permeability of membrane. Under such circumstances, a electroplated layer with more thinly adjusted thickness may improve the permeability coefficient of hydrogen gas.

According to this invention, the vacuumization at the opposite side of electroplated layer during electroplate may deeply prevent the pores present at the surface of support, while reducing the thickness of electroplated layer. The thickness of electroplated layer may vary differently depending on the intensity of vacuumization. In this context, it is preferred that the vacuumization is carried out in the range of 500-650 torr.

The composite membrane manufactured by the above electroplating process of this invention exhibits significantly excellent permeation property to hydrogen gas as well as better permeability and selectivity, compared with the conventional membrane using the common electroplating method.

Examples of some porous support materials according to this invention may include conductive metals such as stainless steel including ceramic or glass coated with a conductive material; hence, it is preferred to use a porous support derived from conductive metals and any of porous support having a flat and suture membranes or tube type may be employed. However, when an palladium alloy is directly electroplated on the surface of such porous support, the membrane structure may be inadequate to separation of hydrogen gas due to relatively thickness of the electroplated layer and presence of pin-hole. Thus, the surface of the support should be modified, while readjusting the pore size.

Generally, the average pore size of porous support used for separation of gas is in the range of 0.01-1  $\mu\text{m}$ ; in this case, the separation of gas is controlled by the Knudsen diffusion which is in inverse to the square root of molecular weight of permeating gas molecules and hence, the selectivity of hydrogen to



nitrogen gas is about 3.7.

According to this invention, some conductive transition metals such as nickel are used to modify the surface of a porous support. In addition, some other conductive materials with a same effect may be used; for example, fine  
5 powders of conductive carbon are coated on the surface of support. When the surface is coated with fine nickel powders, the separation coefficient of hydrogen and nitrogen is measured at about 2.0-2.7. This reflects that the surface is somewhat modified but relatively large pores still exist on the surface of support. Meanwhile, when the surface coated with fine granule of nickel is  
10 copper plated, the separation coefficient of hydrogen and nitrogen is measured at about 3.5-3.7, and this reflects that the adhesive powder between a support and electroplated layer is improved, while the pore size of support becomes smaller. Thus, an palladium alloy is electroplated on a porous support to obtain an electroplated layer in the form of thin membrane without pin hole.

15 One embodiment of this invention designed to electroplate a palladium alloy on a stainless steel support by an electroplating method using an vacuum, is explained in more detail.

The surface of stainless steel support, having pore size of 0.2-0.5  $\mu\text{m}$ , is coated with fine nickel powders with less than 1  $\mu\text{m}$  in size and heated at 700-  
20 850°C for 4-6 hours; hence, the coating amount of nickel powders is in the range of 0.003-0.01g per unit area.

Then, the surface of support is washed with distilled water to remove some dust and impurities and treated with a sulfuric acid solution for activation of the surface. The surface is copper-plated in the range of 200-1,000 mA for  
25 about 3-30 minutes using a bath containing diluted copper cyanide.

The support, so modified from the above procedure, is fixed to a plate cell, immersed in a palladium alloy bath and electroplated, while reducing the pressure at the opposite side of electroplate by less than 650 torr.

In order to assess the performance of the composite membrane for separation of hydrogen gas, so manufactured from the above-mentioned manufacturing method, the permeability was measured by a gas-permeability apparatus at normal state; the adhesion between the composite membrane and permeation cell was performed by a graphite ring; temperature was adjusted by a electric furnace at a outer cell. With such equipments, the composite membrane, which is thinly coated with an palladium alloy compound and transition metal on its support, may be used as a selective membrane for separation of hydrogen gas; hence, the higher temperature is, the larger permeation rate of hydrogen gas becomes and the higher pressure difference of hydrogen gas between the membrane, the larger permeation rate of hydrogen gas also becomes.

The following specific examples are intended to be illustrative of the invention and should not be construed as limiting the scope of the invention as defined by appended claims.

**Manufacturing example: Preparation of a plating solution derived from palladium alloy**

Ethylene diamine was added to 5g of palladium dichloride dissolved in 200ml of distilled water in the molar ratio of 2.2, stirred the mixture and filtered off the unreactants, while passing the vapor. Then, 35% hydrochloric acid was added to the filtered solution in the molar ratio of 2.2, stirred the mixture for about 30 minutes and cooled at 4°C for 24 hours for storage. Thereafter, a palladium complex compound, so precipitated, was filtered off and dried by a vacuum dryer. Hence, the remaining ethylene diamine was separated via a reaction of ethylene diamine with hydrochloric acid to form an ammonium salt, while the palladium complex compound was precipitated in the form of palladium ethylene diamine dichloride.

A mixture containing 10g. of nickel sulfate ( $\text{NiSO}_4 \cdot 6\text{H}_2\text{O}$ ), so prepared from the reaction of nickel with sulfuric acid and 5g of palladium ethylene diamine dichloride, so precipitated from the above process, was dissolved in 300ml of distilled water and with the addition of amidosulfuric acid, the pH of the resulting solution was adjusted at 7.7 to prepare a plating solution. According to the chemical composition of palladium alloy, the weight percent ratio of palladium and nickel was 70:30.

#### Example 1

A stainless steel support was washed with distilled water and NaOH for removal of impurities and then, its surface was activated through treatment with 5% solution of sulfuric acid. The support was immersed in a plate bath containing 0.084M CuCN and 0.2M NaCN to modify the support having the surface plated with copper at 1A for 60-90 minutes. The support, so modified, was fixed in a plate cell, immersed in a bath containing the palladium-alloy plate prepared by the manufacturing example, and electroplated at 35 mA for 2 hours.

The composite membrane, so prepared, was homogeneously plated, and hydrogen gas was selectively flowed through the membrane.

#### Example 2

Fine nickel powders with the size of less than  $1\ \mu\text{m}$  were dispersed on the surface of a stainless steel support and heated at  $800^\circ\text{C}$  for 5 hours. The stainless steel support was washed with distilled water and NaOH for removal of impurities and then, its surface was activated through treatment with 5% solution of sulfuric acid. The support was immersed in a plate bath containing 0.084M CuCN and 0.2M NaCN to modify the support having the surface plated with copper at 1A for 60-90 minutes. The support, so modified, was fixed in a

plate cell, immersed in a bath containing the palladium-alloy plate prepared by the manufacturing example, and electroplated at 35 mA for 2 hours.

The composite membrane, so prepared, was homogeneously plated and extremely stable to any heat. The permeability of the composite to hydrogen and nitrogen gas was shown in the following table 1.

### Example 3

Fine nickel powders with the size of less than 1  $\mu\text{m}$  were dispersed on the surface of a stainless steel support and heated at 800°C for 5 hours. The stainless steel support was washed with distilled water and NaOH for removal of impurities and then, its surface was activated through treatment with 5% solution of sulfuric acid. The support was immersed in a plate bath containing 0.084M CuCN and 0.2M NaCN to modify the support having the surface plated with copper at 1A for 20 minutes. The support, so modified, was fixed in a plate cell, immersed in a bath containing the palladium-alloy plate prepared by the manufacturing example, and electroplated at 40 mA for 50 minutes under vacuum at 660 torr at the opposite of a plated side.

### Example 4

The composite membrane for separation of hydrogen gas was prepared in the same manner as Example 3, except that the electroplating was conducted at 1 A for 3 minutes under vacuum at 660 torr at the opposite of a plated layer.

### Example 5

Fine nickel powders with the size of less than 1  $\mu\text{m}$  were dispersed on the surface of a stainless steel support and heated at 800°C for 5 hours. The stainless steel support was washed with distilled water and NaOH for removal of impurities and then, its surface was activated through treatment with 5%

solution of sulfuric acid. The support was immersed in a plate bath containing 0.084M CuCN and 0.2M NaCN to modify the support having the surface plated with copper at 40mA for 20 minutes. The support, so modified, was fixed in a plate cell and immersed in a bath containing the palladium-alloy plate prepared by the manufacturing example for electroplate. In consideration of the fact that with the lapse of time, the pores of the support became smaller, the support was electroplated at 40 mA for 50 minutes in such a manner that the initial vacuumization was maintained at 660 torr and then reduced at 75 torr each at the intervals of 10 minutes.

The permeability of the composite membrane, so prepared, to hydrogen and nitrogen gas was measured, as shown in Table 1.

#### Example 6

The composite membrane for separation of hydrogen gas was prepared in the same manner as Example 5, except that the copper plate time was determined as 15 minutes, the vacuumization was less reduced by about 125 torr at the intervals of 10 minutes, and the electroplate time was determined as 40 minutes.

The permeation rate of the composite membrane, so prepared, was 90-100  $\text{cm}^3/\text{cm}^2 \cdot \text{cm Hg} \cdot \text{s}$  at 550°C and pressure difference of 82.7 kPa and this permeation rate is ten times as high as composite membrane using palladium. The results of permeability of the composite to hydrogen and nitrogen gas were shown in the following table 1.

#### Comparative example 1

Based on a composite membrane manufactured by the method of electroless plating, its properties such as permeability, thickness of plate and other reaction conditions were shown in the following table 1.

**Comparative example 2**

Based on a composite membrane manufactured by the method of sputtering, its properties such as permeability, thickness of plate and other  
5 reaction conditions were shown in the following table 1.

**Comparative example 3**

Based on a composite membrane manufactured by the method of chemical vapor deposition, its properties such as permeability, thickness of  
10 plate and other reaction conditions were shown in the following table 1.

**Comparative example 4**

Based on a Pd/Ag composite membrane with a thickness of 25.4  $\mu\text{m}$ , the permeability of the membrane was measured at 100psi of pressure difference at  
15 both sides of membrane was shown in the following table 1.

20

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Table 1.

	Permeability ( $\text{cm}^3/\text{cm}^2 \cdot \text{cm Hg} \cdot \text{s}$ )	Selectivity ( $\text{H}_2/\text{N}_2$ )	Thickness of plated- layer ( $\mu\text{m}$ )	Pressure used (kPa)	Temperature used (K)
Example 2	$7.60 \times 10^{-4}$	118.2	7	70	723
Example 5	$7.90 \times 10^{-3}$	572	4	82.7	823
Example 6	$2.62 \times 10^{-2}$	1845	3	82.7	823
Comparative Example 1	$2.94 \times 10^{-3}$	650	11-20	1500	823
Comparative example 2	$4.40 \times 10^{-5}$	5.7	0.25-0.5	200	523
Comparative example 3	$4.12 \times 10^{-3}$	1000	2	100-200	773
Comparative example 4	$2.36 \times 10^{-3}$	-	25.4	700	723

As shown in the above table 1, it was noted that the composite membrane of this invention had better selectivity for hydrogen-nitrogen than some membranes using the conventional method, and this was quite evident in that some membranes based on the conventional method adopted a higher pressure condition to enhance the permeability. In particular, when the palladium alloy electroplate was conducted under vacuum (Examples 5 and 6), the membrane of this invention exhibited better properties than that of the conventional electroplating methods (Example 2, Comparative examples 1-4).

As mentioned above, it is well understood that the composite membrane prepared according to this invention is effective for selective separation of hydrogen gas.

## CLAIMS

What is claimed is:

1. A process for manufacturing a composite membrane for separation of  
5 hydrogen gas using palladium, prepared in such a manner that an alloy  
consisting of a palladium compound and transition metal is electroplated on  
porous support.
2. The method for preparing a composite membrane for separation of  
10 hydrogen gas according to claim 1, wherein a palladium complex compound  
is employed during said electroplating.
3. The method for preparing a composite membrane for separation of  
hydrogen gas according to claim 1, wherein the amount of the palladium  
15 compound from said alloy is more than 50% by weight.
4. The method for preparing a composite membrane for separation of  
hydrogen gas according to claim 1, wherein said transition metal is selected  
from the group consisting of VIII, IB, VIA, IVA and VA group elements.  
20
5. The method for preparing a composite membrane for separation of  
hydrogen gas according to claim 1, wherein the electroplating is conducted  
on the porous support having a pore size of 0.01-1  $\mu\text{m}$  under reduced  
pressure.  
25
6. The method for preparing a composite membrane for separation of  
hydrogen gas according to claim 1, wherein said porous support is derived  
from conductive metals, ceramic ceramic or glass coated with conductive



material.

7. The method for preparing a composite membrane for separation of hydrogen gas according to claim 5, wherein the surface of said porous support is dispersed by a fine granule conductive metal having less than 1  $\mu\text{m}$ , heated, and modified.
8. The method for preparing a composite membrane for separation of hydrogen gas according to claim 5, wherein the surface of said porous support is modified by a copper plating.
9. The method for preparing a composite membrane for separation of hydrogen gas according to claim 1, wherein said porous support is a flat membrane or tube-type support.

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# INTERNATIONAL SEARCH REPORT

		International application No. PCT/KR 98/00461
A. CLASSIFICATION OF SUBJECT MATTER		
IPC <sup>6</sup> : B 01 D 53/22, 67/00, 69/04, 69/06, 69/12, 71/02 // (B 01 D 131:20)		
According to International Patent Classification (IPC) or to both national classification and IPC		
B. FIELDS SEARCHED		
Minimum documentation searched (classification system followed by classification symbols)		
IPC <sup>6</sup> : B 01 D		
Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched		
Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)		
WPIL		
C. DOCUMENTS CONSIDERED TO BE RELEVANT		
Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	WO 97/40 914 A1 (SINTEF) 06 November 1997 (06.11.97), claims.	1
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<input type="checkbox"/> Further documents are listed in the continuation of Box C. <input checked="" type="checkbox"/> See patent family annex.		
* Special categories of cited documents: -A- document defining the general state of the art which is not considered to be of particular relevance -E- earlier application or patent but published on or after the international filing date -L- document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified) -O- document referring to an oral disclosure, use, exhibition or other means -P- document published prior to the international filing date but later than the priority date claimed -T- later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention -X- document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone -Y- document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art -Z- document member of the same patent family		
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# INTERNATIONAL SEARCH REPORT

Information on patent family members

International application No.  
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Im Recherchenbericht angeführtes Patentedokument Patent document cited in search report Document de brevet cité dans le rapport de recherche	Datum der Veröffentlichung Publication date Date de publication	Mitglied(er) der Patentfamilie Patent family member(s) Membre(s) de la famille de brevets	Datum der Veröffentlichung Publication date Date de publication
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